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Unit: mm

TOSHIBA Diode Silicon Epitaxial Schottky Barrier Type

### HN2S03FE

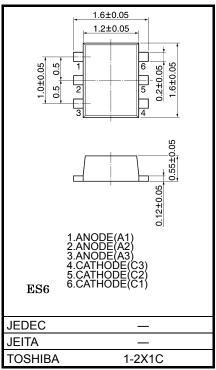
#### **High Speed Switching Applications**

HN2S03FE is composed of 3 independent diodes.
 Low forward voltage : V<sub>F</sub> (3) = 0.50V (typ.)
 Low reverse current : I<sub>R</sub>= 0.5µA (max)
 Small total capacitance : C<sub>T</sub> = 3.9pF (typ.)

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse Voltage	$V_{RM}$	25	V
Reverse voltage	V <sub>R</sub>	20	٧
Maximum (peak) forward current	I <sub>FM</sub>	100 *	mA
Average forward current	Io	50 *	mA
Surge current (10ms)	I <sub>FSM</sub>	1 *	Α
Power dissipation	Р	100 **	mW
Junction temperature	Tj	125	°C
Storage temperature range	T <sub>stg</sub>	–55 to ∼125	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in



Weight: 0.003 g (typ.)

temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

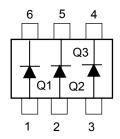
- \* : This is the absolute maximum rating for a single diode (Q1, Q2 or Q3). If two or three diodes are used, the absolute maximum rating per diode is 75 % that of the single diode.
- \*\* :Total rating

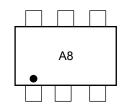
#### Electrical Characteristics (Q1, Q2, Q3 Common, Ta = 25°C)

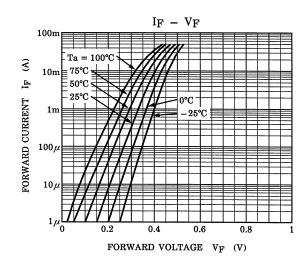
Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit	
Forward voltage	V <sub>F (1)</sub>	_	I <sub>F</sub> = 1mA	1	0.33			
	V <sub>F (2)</sub>	_	I <sub>F</sub> = 5mA	_	0.38	1	V	
	V <sub>F (3)</sub>	_	I <sub>F</sub> = 50mA	_	0.50	0.55		
Reverse current	I <sub>R</sub>	_	V <sub>R</sub> = 20V	_	_	0.5	μΑ	
Total capacitance	C <sub>T</sub>	_	V <sub>R</sub> = 0, f = 1MHz	_	3.9	-	pF	

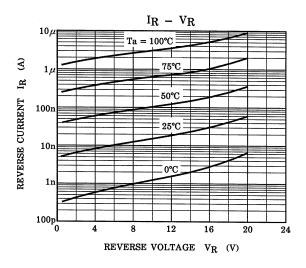
#### **Pin Assignment (Top View)**

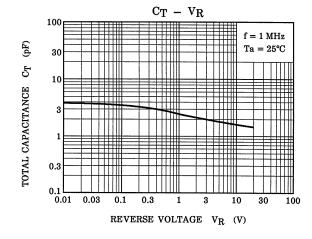
#### Marking

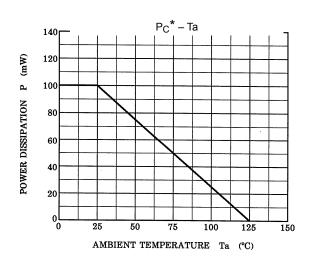












\*:Total Rating

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